

UNISONIC TECHNOLOGIES CO., LTD

3NM100 Preliminary Power MOSFET

3.0A, 1000V N-CHANNEL SUPER-JUNCTION MOSFET

DESCRIPTION

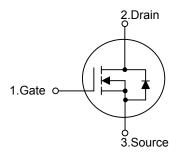
The UTC **3NM100** is an Super Junction MOSFET Structure. It uses UTC advanced planar stripe, DMOS technology to provide customers perfect switching performance, minimal on-state resistance.

The UTC **3NM100** is universally applied in electronic lamp ballasts based on half bridge topology, high efficiency switched mode power supplies, active power factor correction, etc.

■ FEATURES

- * $R_{DS(ON)} \le 4.0 \Omega @ V_{GS} = 10V, I_D = 1.5A$
- * High switching speed
- * High breakdown voltage

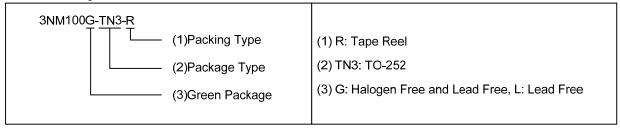
■ SYMBOL



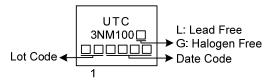
ORDERING INFORMATION

Ordering Number		Doolsono	Pin Assignment			Deeking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3NM100L-TN3-R	3NM100G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



1 TO-252

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■ **ABSOLUTE MAXIMUM RATINGS** (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{ t DSS}$	1000	V	
Drain-Gate Voltage		V_{DGR}	1000	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous	I _D	3	Α	
	Pulsed	I _{DM}	6	Α	
Peak Diode Recovery dv/dt (Note 3)		dv/dt	2.6	V/ns	
Power Dissipation		P_{D}	23	W	
Junction Temperature		TJ	-55 ~ +150	°C	
Storage Temperature Range		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. $I_{SD} \le 3.0$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	θ_{JC}	5.4 (Note)	°C/W	

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

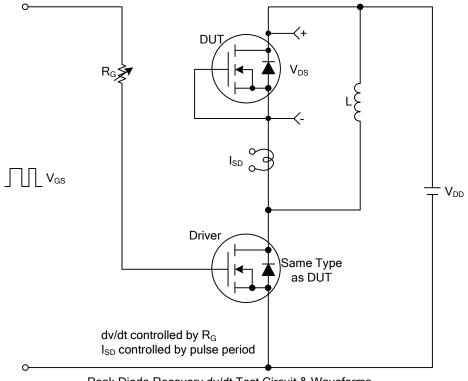
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =0.25mA, V _{GS} =0V, T _J =25°C				V	
Drain-Source Leakage Current			V _{DS} =1000V, V _{GS} =0V, T _J =25°C			10	μΑ	
		I _{DSS}	V _{DS} =1000V, V _{GS} =0V, T _C =125°C			100	μΑ	
Gate-Source Leakage Current	Forward	I _{GSS}	V_{GS} =+30V, V_{DS} =0V			+100	nA	
	Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.5		4.5	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =1.5A			4.0	Ω	
DYNAMIC PARAMETERS								
Input Capacitance		C _{ISS}			250		pF	
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		75		pF	
Reverse Transfer Capacitance		C_{RSS}			4.5		pF	
SWITCHING PARAMETERS								
Total Gate Charge		Q_G	\/ -800\/ \/ -10\/ -2.0A		18		nC	
Gate to Source Charge		Q_GS	V _{DS} =800V, V _{GS} =10V, I _D =3.0A (Note 1,2)		7		nC	
Gate to Drain Charge		Q_GD	(Note 1,2)		3.2		nC	
Turn-ON Delay Time		t _{D(ON)}			6.4		ns	
Rise Time		t_R	V _{DD} =100V, V _{GS} =10V, I _D =3.0A,		17		ns	
Turn-OFF Delay Time		$t_{D(OFF)}$	R _G =25Ω (Note 1,2)		34		ns	
Fall-Time		t_{F}			33		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		I _S	T _C =25°C			3	Α	
Maximum Body-Diode Pulsed Current		I _{SM}	T _C =25°C			6	Α	
Drain-Source Diode Forward Voltage		V_{SD}	I _F =3.0A, V _{GS} =0V			1.4	V	
Reverse Recovery Time		t _{rr}	I _S =3.0A,V _{GS} =0V,		480		ns	
Reverse Recovery Charge		Q_{rr}	dI _F /dt=100A/μs (Note 1)		3		μC	

Notes: 1. Pulse Test: Pulse width $\leq 300 \mu s$, Duty cycle $\leq 2\%$.

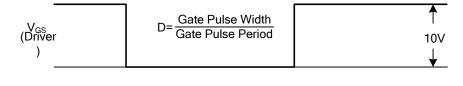
2. Essentially independent of operating temperature.

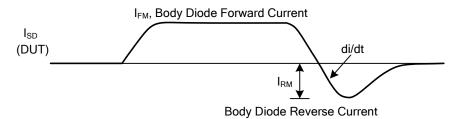


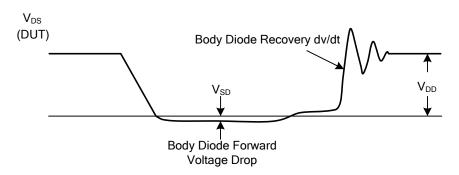
TEST CIRCUITS AND WAVEFORMS



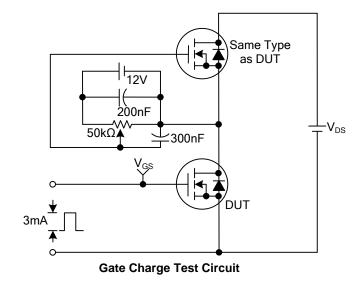
Peak Diode Recovery dv/dt Test Circuit & Waveforms

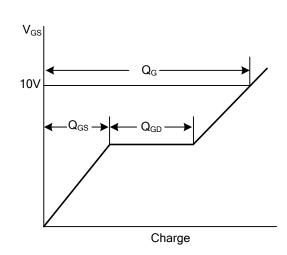




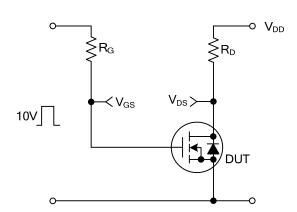


■ TEST CIRCUITS AND WAVEFORMS(Cont.)

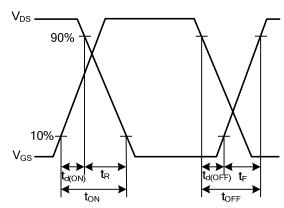




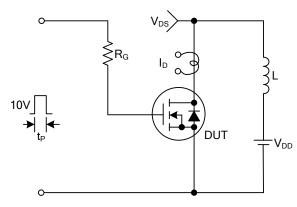
Gate Charge Waveforms



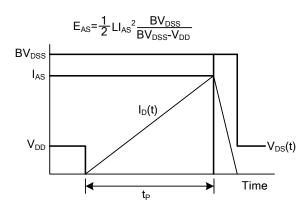
Resistive Switching Test Circuit



Resistive Switching Waveforms



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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